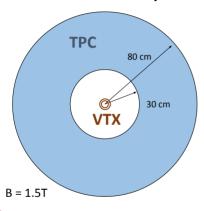
Outline

I was asked to give a high-level overview of how the TPC software works

Most of the following slide have largely been shown before, but perhaps not everyone has seen them. If any detail you want to know is missing, just interrupt

Slides from April pre-review

A sPHENIX Tracking Solution: TPC & 2 Pixel Layers



Stony Brook University

Design parameters and performance consistent with ILC TPC prototypes

TPC

- T2K gas volume from 30cm to 80cm
- $|y| < 1 \rightarrow z_{max} \sim \pm 80 cm$
- 60 radial readout layer with $\Delta r \simeq 8mm$
- Readout plane with 1.2mm pads in rφ
 approximately 350,000 readout channel
- Assume 40 MHz FADC → Δz ~ 2mm
 approximately 400 samples per readout channel

VTX layers 1 & 2

Silicon tracker design

Alan Dion

T2K Gas and Response of Readout Plane

Gas properties (Ar(95%) $CF_4(3\%)$ Isob(2%)), based on ILC prototype measurements and verified with Magboltz, ionization from PDG:

•
$$v^{t} \approx 6 \text{ cm/us at} \approx 150 \text{ V/cm}$$

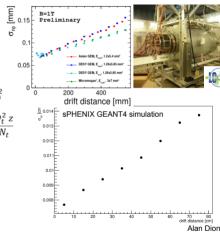
$$N_t$$
 = 38 electrons/keV
 $V_{drit} \approx 6 \text{ cm/µs}$ at $\sim 150 \text{ V/cm}$
 $D_t \approx 57 \text{ µm//cm}$ in 1.45 T field $\sigma_{r\varphi}^2 = \frac{D_t^2 z}{N_t} + \sigma_0^2$
 $V_t \approx 11633 \text{ cm}$ $\sigma_{r\varphi}^2 = \frac{D_t^2 z}{N_t} + \sigma_0^2$

$$\sigma_z^2 = (1 + w_t^2) \frac{D_t^2 z}{N_t}$$

Charge sharing between 2-3 pads of 1.2mm, based on ILC prototype measurements:

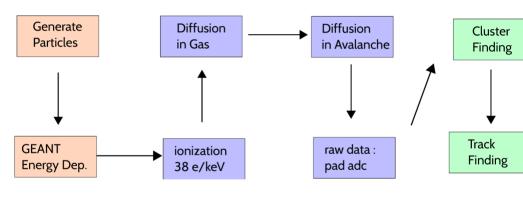
- $\sigma_{\text{charge}} = 300 \,\mu\text{m}$ in triple GEM $\sigma_{0} = 70-80 \,\mu\text{m}$





Slides from April pre-review

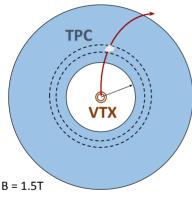
Flow Chart of GEANT Simulation & Analysis



Stony Brook University

Alan Dion

TPC Charge Cloud Generation & Diffusion



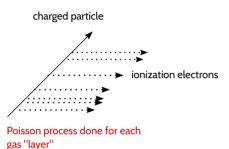
TPC in GEANT

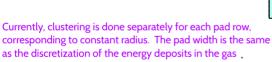
- Record ΔE in radial drift cylinder slice
- Convert to charge cloud along track segment
- Diffuse charge cloud along z for T2K gas in 1.5 T Bfield with 220 V/cm E-field
- Distribute Cloud along pads, fit with cluster-finder

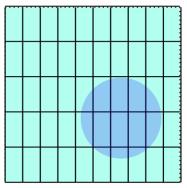


Alan Dion

A little more detail







r-phi pad plane filled with ADC from number of electrons (gain tunable through digitizer class)

On the to-do list to change after the merge!

resolution for hit reconstruction in the z-direction is just mocked up as a single number

In reality, there will be a shaper pulse which gives us timing information

Not sure how much detail we really want to add at this point

Pattern recognition

The pattern recognition roughly consists of 3 steps:

- · Hough transform
 - selects a few hits per layer such that there is likely a track
 - can't do better than that due to multiple scattering, energy loss, field deformity
- · Combinatorial algorithm
 - some sort of fast statistical check on remaining hit combinations which takes multiple scattering into account
 - for the SVTX, I just eat the $n_{\rm bits}^{n_{\rm layers}}$. Not viable for TPC
- Kalman filter
 - selects the remaining based on a variable which should closely follow a χ^2 distribution

The second step has been completely changed on the TPC branch. Should there be a flag to select the algorithm, or should the software try to figure it out from the geometry?